456SDE Series Fuse NANO2® > Fast Acting Fuse





Web Resources



Download ECAD models, order samples, and find technical recources at www.littelfuse.com

Electrical Characteristics

% of Ampere Rating	Opening Time
100%	4 hours, Minimum
200%	60 seconds, Maximum

Description

The High Current NANO2® Fuse is a small square surface mount fuse that is designed to support higher current requirements of various applications.

Features & Benefits

- Available in ratings of 40 A to 60 A
- High interrupting rating of 600 A @ 80 VDC
- Very low cold resistance, temperature rise, and voltage drop
- Surface mountable high current fuse
- UL Recognized UL/CSA/ NMX 248-1 and UL/CSA/NMX 248-14

- Single fuse solution for high current application
- Suitable for a wide variety of voltage requirements and applications
- Enhances power efficiency
- Avoids nuisance opening due to high inrush and surge current inherent in the system
- Compatible with high volume assembly requirements

Applications

- Voltage regulator Module for PC Server
- Cooling Fan System for PC Server
- Storage System Power
- Basestation Power Supply
- Power Tools

Agency Approvals

Agency	Agency File/Certificate Number	Ampere Rating	
c FL °us	E10480	40 A –60 A	

Electrical Specifications

Ampere Rating (A)	Amp Code	Max Voltage Rating (V)	Interrupting Rating⁴	Nominal Cold Resistance (Ohms)	Nominal Melting I ² t (A ² Sec.)	Nom Voltage Drop (mV)	Agency Approvals
40	040.	250	150A @ 250VAC 600A @ 80VDC	0.00130	1700	110	X
50	050.	250	150A @ 250VAC 600A @ 80VDC	0.00105	2700	115	X
60	060.	250	150A @ 250VAC 600A @ 80VDC	0.00085	4260	106	X

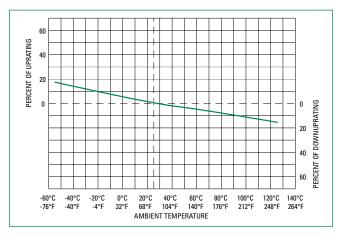
Notes:

- Cold resistance measured at less than 10% of rated current at 23° C.
- 2. Agency Approval Table Key: X = Approved or Certified, P = Pending.
- 3. I2t values stated for 8msec opening time.



456SDE Series Fuse NAN02® > Fast Acting Fuse

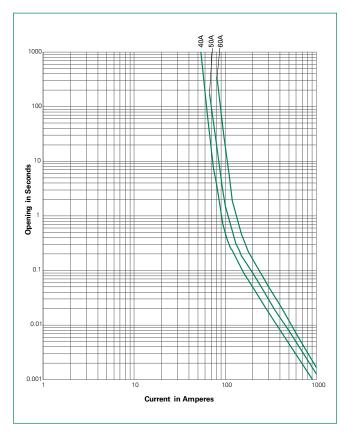
Temperature Re-rating Curve



Note:

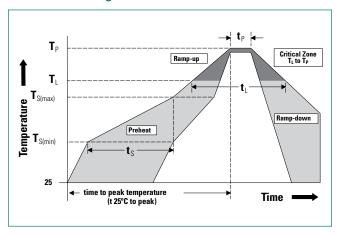
1. Rerating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

Average Time Current Curves



Soldering Parameters - Reflow Soldering

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (Min to Max) (t _s)	60 – 180 secs	
Average ramp up rate (Liquidus Temp (T_L) to peak		5°C/second max.	
T _{S(max)} to T _L - Ramp-up Rate		5°C/second max.	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	- Temperature (t _L)	60 - 150 seconds	
Peak Temperature (T _P)		260 ^{+0/-5} °C	
Time within 5°C of actual peak Temperature (t _p)		20 – 40 seconds	
Ramp-down Rate		5°C/second max.	
Time 25°C to peak Temperature (T _p)		8 minutes max.	
Do not exceed		260°C	



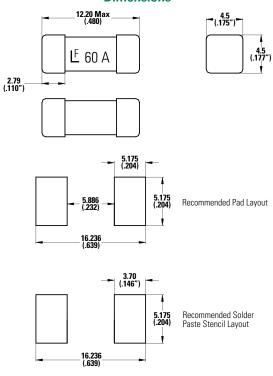


456SDE Series Fuse NAN02® > Fast Acting Fuse

Product Characteristics

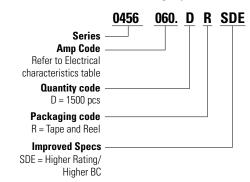
Materials	Body: Ceramic		
	Cap: Silver Plated Brass		
Product Marking	Body: Brand Logo, Current Rating		
Insulation Resistance	MIL-STD-202, method 302, Test Condition A (10,000 ohms, Minimum)		
Solderability	MIL-STD-202, Method 208		
Resistance to	MIL-STD-202, Method 210,		
Soldering Heat	Test Condition B (10 sec at 260°C)		
PCB Recommendation for Thermal Management	Minimum copper trace width = 15 mm (40 A)/25 mm (50 A/60 A) Recommended copper trace weight = 3oz (40A) / 6oz (50 A/60 A) For PSE requirements: Minimum Copper trace width = 35mm Recommended Copper trace weight = 6oz Alternate methods of thermal management may be used. In such cases, under normal operations, the maximum temperature of the fuse body should not exceed 90OC in a 25OC environment.		

Dimensions



Operating Temperature -55°C to 125°C with proper derating MIL-STD-202, Method 107, Test **Thermal Shock** Condition B (5 cycles -65°C to 125°C) Vibration MIL-STD-202, Method 201 (10-55 Hz) **Moisture Sensitivity Level** J-STD-020, Level 1 MIL-STD-202 Method 106, **Moisture Resistance** High Humidity (90-98%RH), Heat (65°C) MIL-STD-202, Method 101, Salt Spray Test Condition B MIL-STD-202, Method 213, **Mechanical Shock** Test Condition I (100 G's peak for 6 milliseconds)

Part Numbering System



Packaging

Rating	Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
40 A-60 A	24 mm Tape and Reel	EIA RS-481-2 (IEC 286, Part 3)	1500	DR

Note: Recommended Stencil Thickness: 0.152mm Dimensions are in millimeters (inches)

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